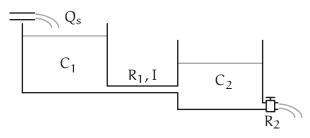
thermoflu.exe Exercises for Chapter thermoflu

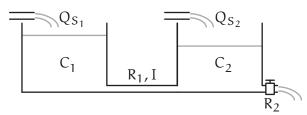
Exercise thermoflu.tinker

Draw a linear graph of the fluid system with schematic below.



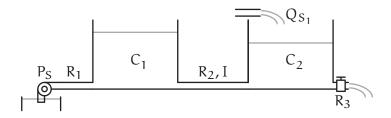
Exercise thermoflu.tailor

Draw a linear graph of the fluid system with schematic below.



Exercise thermoflu.soldier

(a) Draw a linear graph of the fluid system with schematic below. (b) Draw a normal tree and identify the state variables and system order.



Exercise thermoflu.tpain

_/25 p. Consider an apparatus with two chambers filled with gas at potentially different temperatures illustrated in Fig. exe.1. Temperature sensors

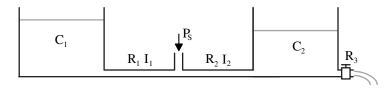
are embedded in the two "sensor blocks," made of copper for low thermal resistance and made large enough to provide enough thermal capacitance to smooth out temperature fluctuations.⁴ The "structural conduit" is made of steel, less thermally conductive, but conductive nonetheless. The conduit provides structure to the apparatus and is hollow to allow the sensor wires to run through. A concern with this apparatus is that the temperature in one chamber will affect the temperature in the other, most conspicuously by heat conducting through the structural conduit. We will begin an analysis of the thermal isolation of the two chambers and temperature measurements. Develop a thermal lumped-parameter model as follows.

- a. Describe the lumped-parameter elements you will use to model the system.
- b. Draw a linear graph of the lumped-parameter model.
- c. Superimpose a normal tree on the graph, identify the system order, and choose the state variables.

Exercise thermoflu.morocco

For the system below with a pressure source P_s , _____/20 p. fluid resistances R_i , fluid inertances I_i , and fluid capacitances C_i , find

- 1. the linear graph,
- 2. the normal tree, and
- 3. the system state variables and system order.



4. This technique of adding capacitance for smoothing a signal is useful in all energy domains!

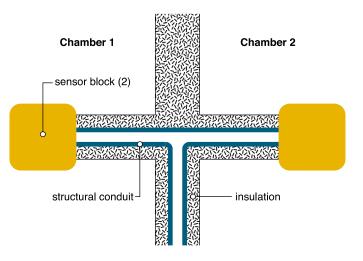


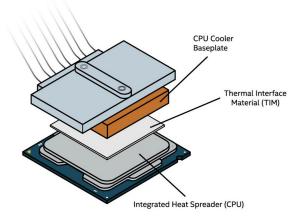
Figure exe.1: a diagram of the two-chamber apparatus.

_/20 p.

Exercise thermoflu.taiwan

The cooling system for a desktop computer CPU is shown below. We can consider the CPU as a heat flow source Q_s . A thermal interface material is then used to transfer heat from the CPU to the cooling system. However, this thermal interface material is not a perfect thermal conductor. The cooling system then consists of a base plate with thermal capacitance and a "heat pipe" which moves the heat away from the CPU. The "heat pipe" is again an imperfect thermal conductor. At the other end of the "heat pipe" is a constant temperate (which we can model as a temperature source). For this system, find

- 1. the linear graph,
- 2. the normal tree, and
- 3. the system state variables and system order.



Part IV

Fourier analysis



Fourier series and transforms